

Description

The HTH2D25P600H is an internally Input/Output pre-matched discrete GaN on SiC HEMT Power Amplifier with 600W saturated output power covering frequency range from 2.4 to 2.5 GHz.

Features

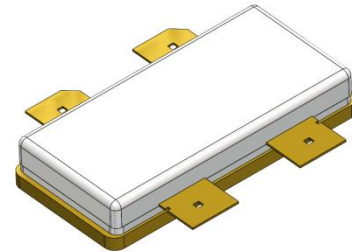
- Operating Frequency Range: 2.4 - 2.5 GHz
- Operating Drain Voltage: 48V
- Saturation Output Power: 600W
- Excellent thermal stability due to low thermal resistance package
- Enhanced robustness design without device degradation
- Internally integrated enhanced ESD design

Applications

- RF Industrial Heating and Drying
- Solid-state Commercial and Industrial Cooking
- Plasma Lighting
- Semiconductor Equipment
- Automotive Ignition
- Medical & Scientific Sciences

Ordering Information

Part Number	Description
HTH2D25P600H	Tray Package
HTH2D25P600H EVB	2.4-2.5 GHz EVB

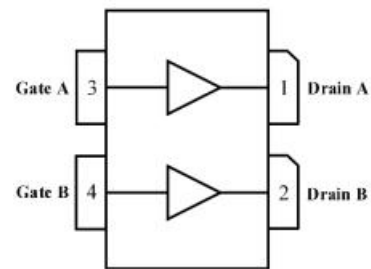


ACC2110S-4L

Earless Flanged Balanced
Air Cavity Ceramic Package; 4 Leads



HTH2D25P600H



(Top View)

Note: Exposed backside of the package is the source terminal for the transistor

Pin Connections

Typical Performance

RF Characteristics (Pulsed-CW)

Freq (MHz)	P3dB (dBm)	P3dB (W)	Gain (dB)	Eff(%)@P3dB
2400	58.11	647.1	19.0	73.66
2450	57.72	591.5	19.1	75.85
2500	57.27	533.3	18.2	76.1

Test conditions unless otherwise noted: 25 °C, VDD = +48Vdc, IDQ =100mA, PW = 100us, Duty cycle= 10% tested on WATECH Application Board

RF Characteristics (CW)

Freq (MHz)	P3dB (dBm)	P3dB (W)	Gain (dB)	Eff(%)@P3dB
2400	57.14	517.6	18.0	67.71
2450	57.01	502.3	18.1	69.93
2500	56.75	473.1	17.4	71.45

Test conditions unless otherwise noted: 25 °C, VDD = +48Vdc, IDQ =100mA, CW, tested on WATECH Application Board

Absolute Maximum Ratings

Parameter	Range/Value	Unit
Drain voltage (V _{DSS})	0 to 150	V
Gate voltage (V _{GS})	-10 to 2	V
Storage Temperature (T _{STG})	-55 to 150	°C
Junction Temperature (T _J)	225	°C

Electrical Specification

DC Characteristics

Parameter	Conditions	Min	Typ	Max	Unit
Breakdown Voltage V _{(BR)DSS}	V _{gs} = -10V, I _{ds} =37.8mA	130	-	-	V
Gate-Source Threshold Voltage V _{GS(th)}	V _{ds} =10V, I _{ds} =37.8mA	-	-2.8	-	V
Drain Leakage Current I _{DSS}	V _{gs} = -10V, V _{ds} =50V	-	-	37.8	mA
Gate Leakage Current I _{GSS}	V _{gs} =-10V, V _{ds} =0V	-	-	37.8	mA

Load Mismatch Test

Condition	Test Result
VSWR=10:1 at all Phase Angles, $V_{DD} = +48V_{dc}$, $I_{DQ}=100mA$, $P_{AVG} = 580W$, PW = 100us, DC= 10%, freq@2450 MHz	No Device Degradation

Thermal Information

Parameter	Condition	Value (Typ)	Unit
Thermal Resistance Junction to Case (R_{TH})	$T_j = 89^{\circ}C$, measured under DC condition	0.4	$^{\circ}C / W$

Load Pull Performance

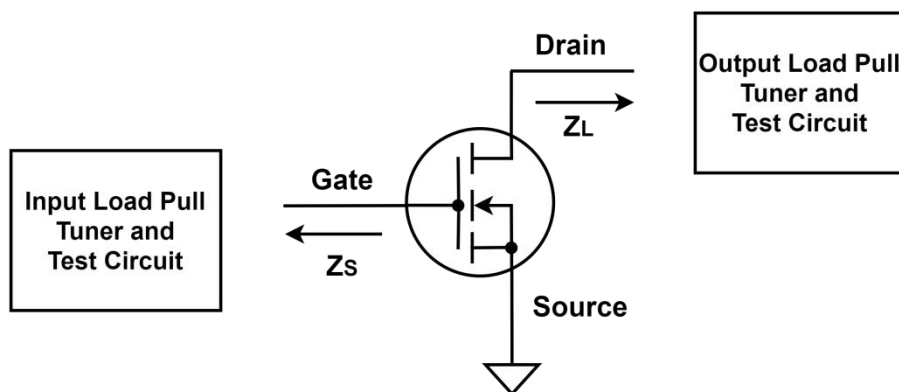
Test conditions unless otherwise noted: $25^{\circ}C$, $V_{DD} = +48V_{dc}$, $I_{DQ} = 100mA$, PW = 100us, DC= 10%

Max Output Power						
Freq (MHz)	Z_{source} (Ω)	Z_{load} [1] (Ω)	Gain (dB)	P3dB (dBm)	P3dB (W)	Eff (%)
2400	$4.1+j*1$	$6.9-j*5.6$	19.0	58.65	733	66.5
2500	$2.4+j*0.5$	$8.6-j*4.6$	18.5	58.96	787	68.0

[1] Load impedance for optimum P3dB pout

Max Drain Efficiency						
Freq (MHz)	Z_{source} (Ω)	Z_{load} [2] (Ω)	Gain (dB)	P3dB (dBm)	P3dB (W)	Eff (%)
2400	$4.1+j*1$	$2.8-j*5.2$	19.7	56.72	470	76.1
2500	$2.4+j*0.5$	$3.9-j*5.5$	20.0	56.80	478	76.4

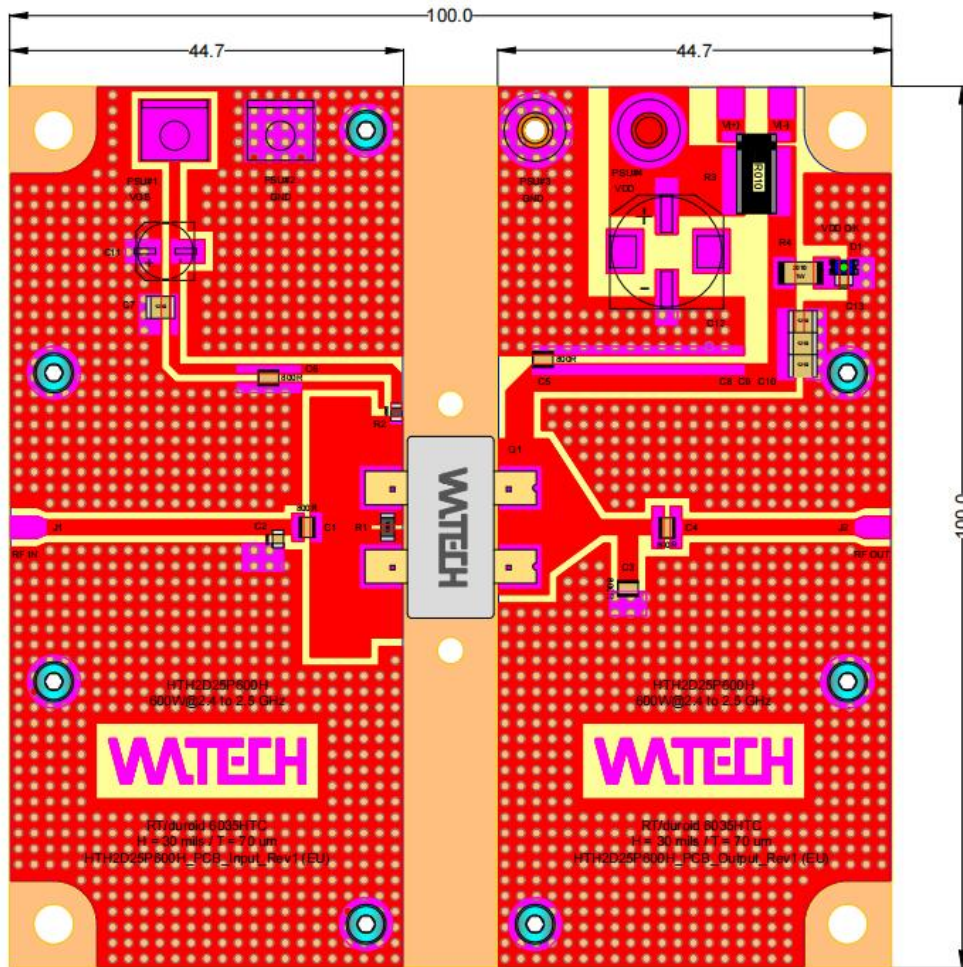
[2] Load impedance for optimum P3dB efficiency



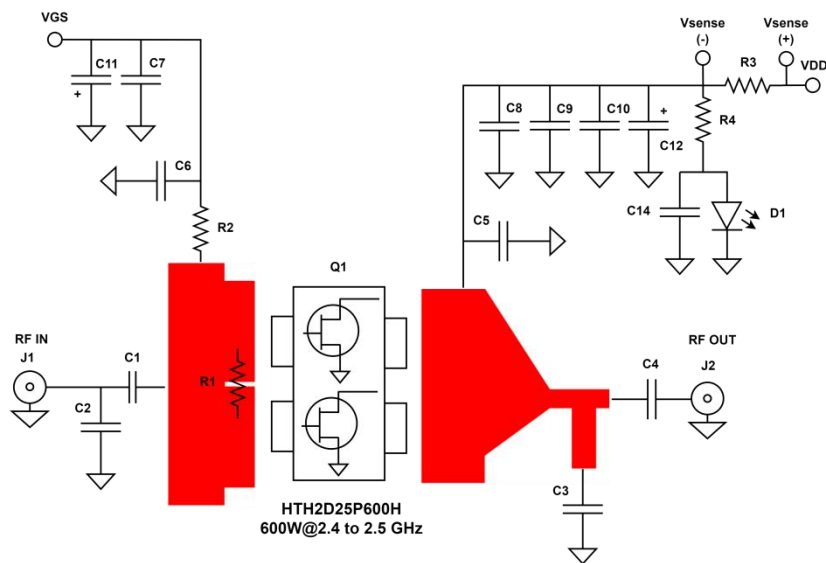
Z_{source} : Measured impedance presented to the input of the device at the package reference plane

Z_{load} : Measured impedance presented to the output of the device at the package reference plane

HTH2D25P600H 2.4-2.5GHz Reference Design



EVB Layout HTH2D25P600H @2.4-2.5GHz Reference Design



Schematic HTH2D25P600H @2.4-2.5GHz Reference Design



HTH2D25P600H

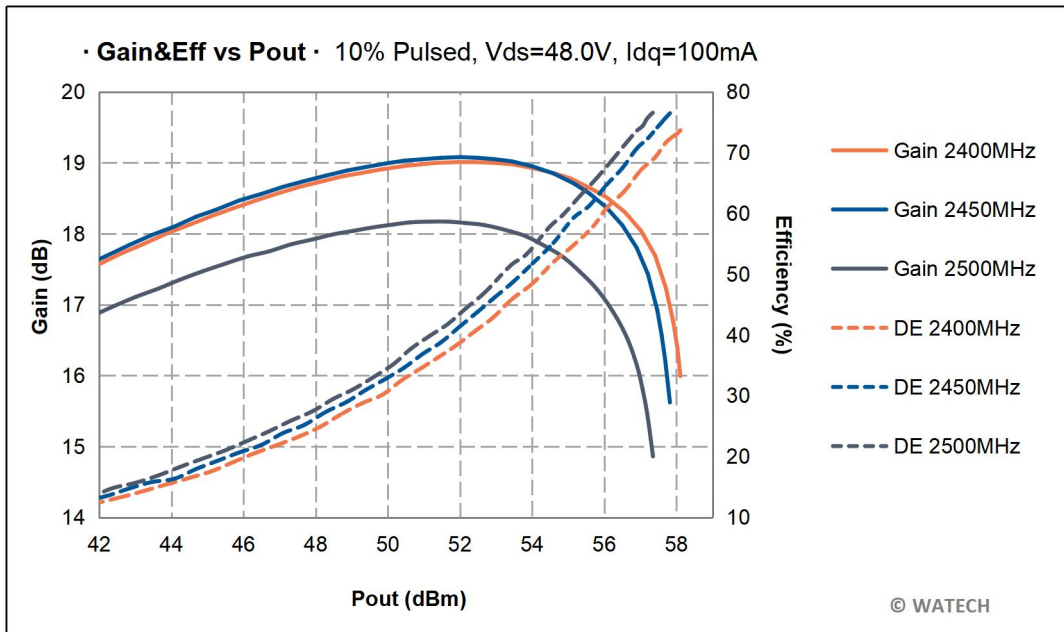
600W, 2.4 - 2.5 GHz GaN Amplifier

Product datasheet

Bill of Materials (BoM) - HTH2D25P600H 2.4-2.5GHz Reference Design

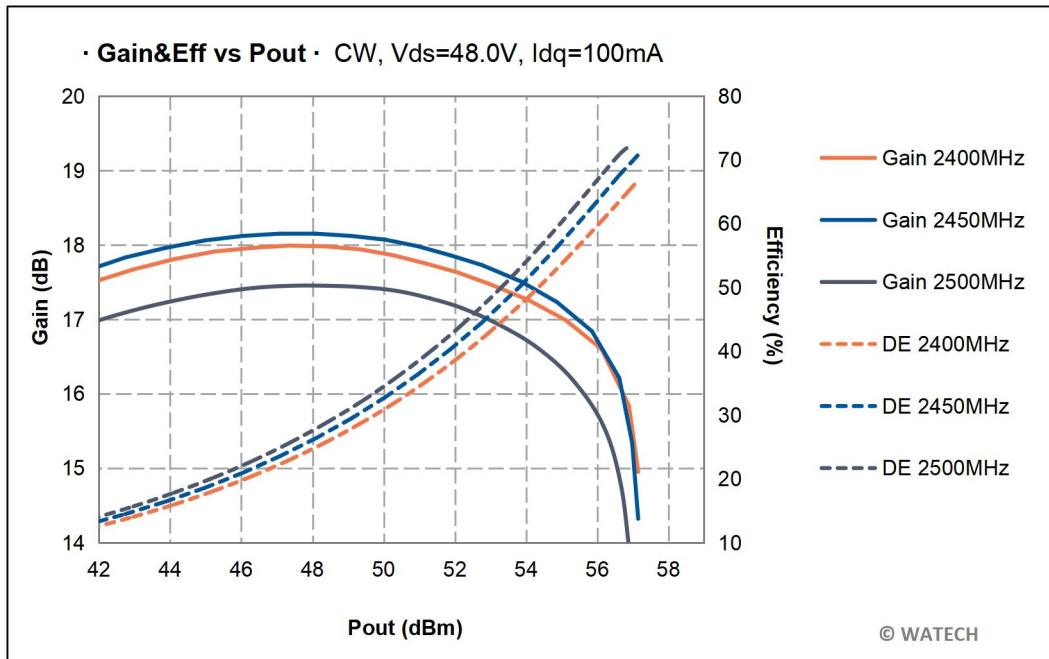
Reference	Value	Description	Manufacturer	P/N
Q1	-	600W, 2400 - 2500 MHz GaN on SiC Amplifier	WATECH	HTH2D25P600H
C1	15pF/500VDC	MLCC	Dalicap	DLC70B150JW501XT
C2	1p8F/250VDC	MLCC	Murata	GRM21A5C2E1R8FW01
C3	0p4F/500VDC	MLCC	Dalicap	DLC70B0R4JW501XT
C4	15pF/500VDC	MLCC	Dalicap	DLC70B150JW501XT
C5	24pF/500VDC	MLCC	Dalicap	DLC70B240JW501XT
C6	24pF/250VDC	MLCC	Murata	GRM21A5C2E240FW01
C7,C8, C9, C10	10uF/100VDC/1210	MLCC	Murata GRM	GRM32EC72A106KE05L
C11	22uF/35VDC	Aluminium Electrolytic Capacitor SMD	Nichicon	UWT1V220MCL1GB
C12	470uF/100VDC	Aluminium Electrolytic Capacitor SMD	Vishay	MAL215099913E3
R1	3.9Ω/1206	Thick Film Resistor	KOA	RK73B2BTDD3R9J
R2	22Ω/0805	Thick Film Resistor	KOA	RK73B2ATTDD220J
R3	1mΩ/ 2%/4W	Current Sense Resistors - SMD	Ohmite	FC4L90R001GER
Diode Circuit				
D1	1206 w/LENS GREEN 570nm	Standard LED - SMD	Dialight	599-0460-127F
R4	1K3Ω/1%/1206	Thick Film Resistor	Vishay	CRCW12061K30FKEAHP
C13	1nF/250VDC/0805	MLCC	TDK	C2012X7R2E102M085AE
Connectors and PCB				
PSU#1, PSU#2	n/a	Terminals .250 FAST TAB	TE Connectivity	42117-2
PSU#3, PSU#4	n/a	Terminals WPSMBU SMT Bush Type A M3 Thread	Würth Elektronik	7466003
J1, J2	n/a	N-type Panel Connector (F)	Amphenol	172228
PCB	RT/Duroid 6035HTC (er = 3.5 ± 0.05), 30 mil (0.762 mm), 70 μm (2oz)			

Performance Plots



Pulsed CW, Gain and Eff vs Pout

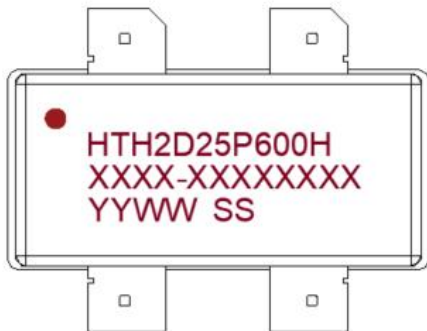
Test conditions unless otherwise noted: 25 °C, VDD = +48Vdc, IDQ = 100 mA, PW = 100us, Duty Cycle = 10% tested on WATECH Application Board



CW, Gain and Eff vs Pout

Test conditions unless otherwise noted: 25 °C, VDD = +48Vdc, IDQ = 100 mA, CW tested on WATECH Application Board

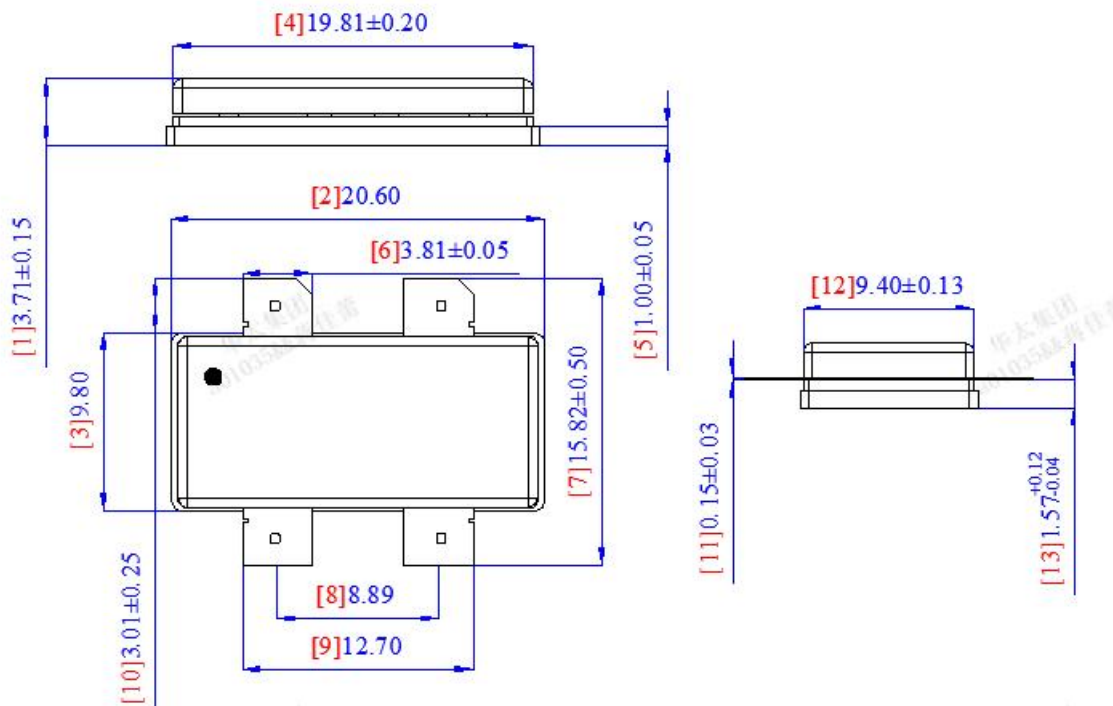
Package Marking and Dimensions



- Line1 (fixed): Device name in work order
- Line2 (unfixed): Mark Lot number in work order (Sample: E596-EERA0001)
- Line3 (unfixed): Date Code + "SS" (The last two digits of sub lot Number)

This Marking SPEC only stipulates the content of Marking. For marking requirements such as font and size, please refer to the latest version of "Watech Product Printing Specification"

Marking



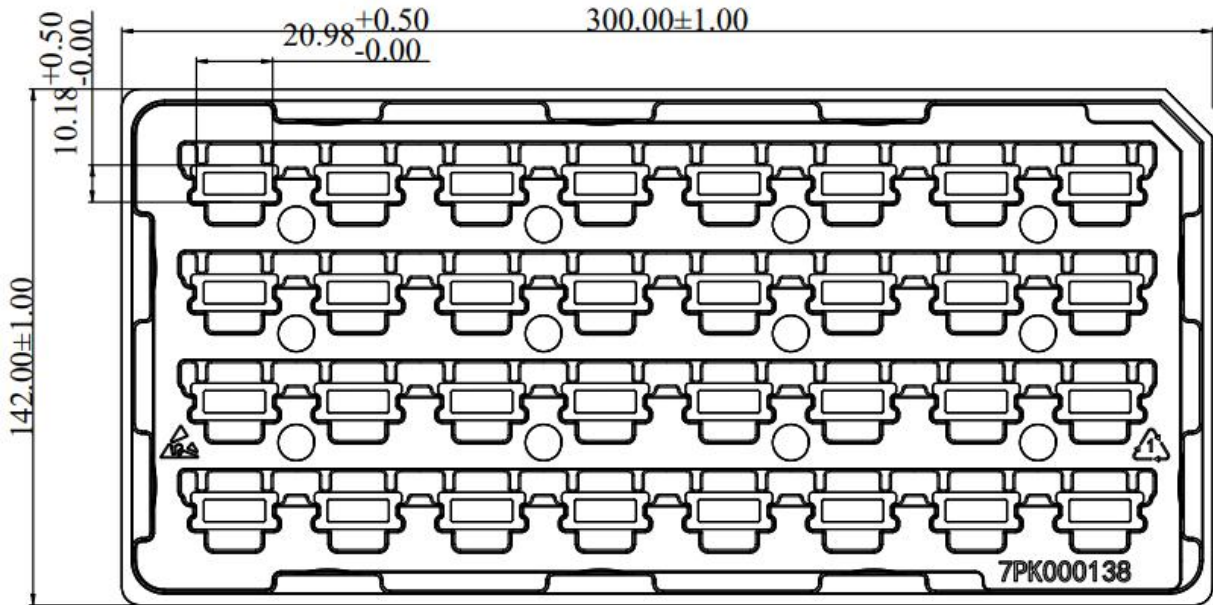
Package Dimensions

ACC2110S-4L Earless Flanged Balanced Air Cavity Ceramic Package; 4 leads

Packing Information

HTH2D25P600H:

Package Type	Qty/Tray(pcs)	Qty/Box(pcs)	Qty/Carton(pcs)
ACC2110S-4L	32	160	960



Packaging Descriptions

Handling Precautions

Parameter	Rating	Standard	
ESD – Human Body Model (HBM)	Class 1B	JESD22-A114	
ESD – Human Body Model (MM)	Class A	EIA/JESD22-A115	
ESD – Charged Device Model (CDM)	Class III	JESD22-C101	

RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU.



Datasheet Status

Document status	Product status	Definition
Objective Datasheet	Design simulation	Product objective specification
Preliminary Datasheet	Customer sample	Engineering samples and first test results
Product Datasheet	Mass production	Final product specification

Abbreviations

Acronym	Definition
GaN	Gallium Nitride
CW	Continuous Waveform

Revision history

Document ID	Datasheet Status	Release Date	Revision Version
Rev 1.0	Objective	Nov. 2023	New format based on English version datasheet
Rev 1.1	Product	May.2024	Product version datasheet
Rev 1.2	Product	Jun.2024	Update CW test result
Rev 1.3	Product	Jun.2024	Update CW test plot
Rev 1.4	Product	Jun.2024	New product version datasheet



HTH2D25P600H

600W, 2.4 - 2.5 GHz GaN Amplifier

Product datasheet

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations and information about WATECH:

- Web: www.watechelectronics.com
- Email: MKT@huatai-elec.com

For technical questions and application information:

- Email: MKT@huatai-elec.com

Important Notice

Information in this document is believed to be accurate and reliable. However, WATECH does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

“Typical” parameters are the average values expected by WATECH in large quantities and are provided for information purposes only. All information and specifications contained herein are subject to change without notice and customers should obtain and verify the latest relevant information before placing orders for WATECH products.

The information contained herein or any use of such information does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other intellectual property rights, whether with regard to such information itself or anything described by such information.

Applications that are described herein for any of these products are for illustrative purposes only. WATECH makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification. Customers are responsible for the design and operation of their applications and products using WATECH products, and WATECH accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the WATECH product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third-party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

WATECH products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of a WATECH product can reasonably be expected to result in personal injury, death or severe property or environmental damage. This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.